Vishay Semiconductors

GA300TD60S

Dual INT-A-PAK Low Profile "Half-Bridge" (Standard Speed IGBT), 300 A



Dual INT-A-PAK Low Profile

PRODUCT SUMMARY

FEATURES

- · Generation 4 IGBT technology
- Standard: Optimized for hard switching speed RoHS DC to 1 kHz
- Low V_{CE(on)}
- Square RBSOA
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- · Industry standard package
- Al₂O₃ DBC
- UL approved file E78996
- Compliant to RoHS Directive 2002/95/EC
- Designed for industrial level

BENEFITS

- Increased operating efficiency
- · Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- · Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current	I _C ⁽¹⁾	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	530		
	IC (.)	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	376		
Pulsed collector current	I _{CM}		800	А	
Clamped inductive load current	I _{LM}		800	A	
Diode continuous forward current	I _F	T _C = 25 °C	219		
		$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	145		
Gate to emitter voltage	V _{GE}		± 20	V	
Maximum power dissipation (IGBT)	P _D	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	1136	w	
		$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	636		
RMS isolation voltage	VISOL	Any terminal to case (V _{RMS} t = 1 s, T _J = 25 °C)	3500	V	

Note

⁽¹⁾ Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals



V _{CES}	600 V
I_C DC at T_C = 25 °C	530 A
$V_{CE(on)}$ (typical) at 300 A, 25 $^\circ\text{C}$	1.24 V

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ELECTRICAL SPECIFICATIONS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE}=0~V,~I_C=500~\mu A$	600	-	-		
Collector to emitter voltage	V _{CE(on)}	V_{GE} = 15 V, I _C = 150 A	-	1.04	1.15		
		V_{GE} = 15 V, I _C = 300 A	-	1.24	1.45	v	
		V_{GE} = 15 V, I_C = 150 A, T_J = 125 $^\circ C$	-	0.96	1.06		
		V_{GE} = 15 V, I_C = 300 A, T_J = 125 $^\circ C$	-	1.22	1.42		
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$	2.9	4.8	6.3		
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$	-	0.02	0.75	m (
		V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 125 $^{\circ}C$	-	1.5	10	mA	
Diode forward voltage drop	V _{FM}	I _{FM} = 150 A	-	1.23	1.39	v	
		I _{FM} = 300 A	-	1.48	1.75		
		I _{FM} = 150 A, T _J = 125 °C	-	1.17	1.33		
		I _{FM} = 300 A, T _J = 125 °C	-	1.50	1.77		
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V =		± 200	nA		

SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Turn-on switching loss	Eon		-	9	-		
Turn-off switching loss	E _{off}	I _C = 300 A, V _{CC} = 360 V, V _{GE} = 15 V, R _a = 1.5 Ω, L = 500 μH, T _J = 25 °C	-	90	-		
Total switching loss	E _{tot}		-	99	-		
Turn-on switching loss	E _{on}		-	23	-	mJ	
Turn-off switching loss	E _{off}		-	133	-		
Total switching loss	E _{tot}		-	156	-		
Turn-on delay time	t _{d(on)}	I _C = 300 A, V _{CC} = 360 V, V _{GE} = 15 V, R _q = 1.5 Ω, L = 500 μH, T _J = 125 °C	-	442	-		
Rise time	t _r		-	301	-	ns	
Turn-off delay time	t _{d(off)}		-	406	-		
Fall time	t _f		-	1570	-		
Reverse bias safe operating area	RBSOA	$ \begin{array}{l} T_{J} = 150 \ ^{\circ}\text{C}, \ I_{C} = 800 \ \text{A}, \ V_{CC} = 400 \ \text{V} \\ V_{P} = 600 \ \text{V}, \ R_{g} = 22 \ \Omega, \ V_{GE} = 15 \ \text{V} \ \text{to} \ 0 \ \text{V}, \\ L = 500 \ \mu\text{H} \end{array} $ Fullsquare					
Diode reverse recovery time	t _{rr}		-	150	179	ns	
Diode peak reverse current	I _{rr}	I _F = 300 A, dI _F /dt = 500 A/μs, V _{CC} = 400 V, T _J = 25 °C	-	43	59	А	
Diode recovery charge	Q _{rr}	· · · · · · · · · · · · · · · · · · ·	-	3.9	6.3	μC	
Diode reverse recovery time	t _{rr}		-	236	265	ns	
Diode peak reverse current	I _{rr}	I _F = 300 A, dI _F /dt = 500 A/μs, V _{CC} = 400 V, T _J = 125 °C	-	64	80	А	
Diode recovery charge	Q _{rr}		-	8.6	11.1	μC	

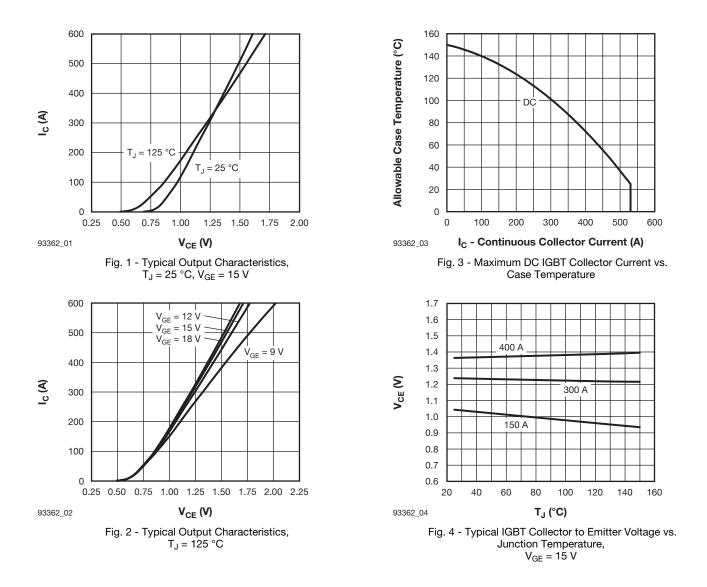
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THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction and storage temperature range		T _J , T _{Stg}	- 40	-	150	°C
IGB		P	-	-	0.11	
Junction to case per leg	Diode	R _{thJC}	-	-	0.4	°C/W
Case to sink per module		R _{thCS}	-	0.05	-	-
Mounting torque	case to heatsink: M6 screw		4	-	6	Nim
	case to terminal 1, 2, 3: M5 screw		2	-	4	Nm
Weight			-	270	-	g



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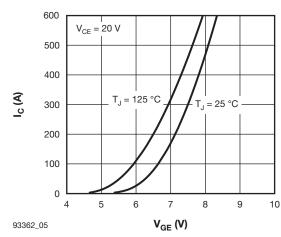
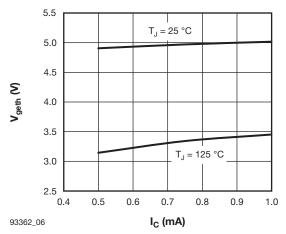
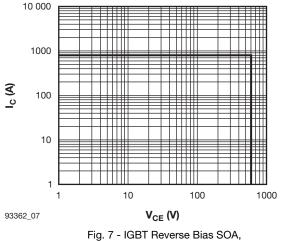


Fig. 5 - Typical IGBT Transfer Characteristics









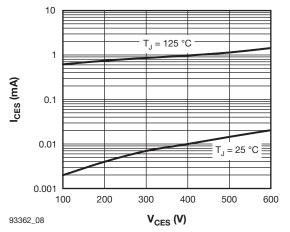
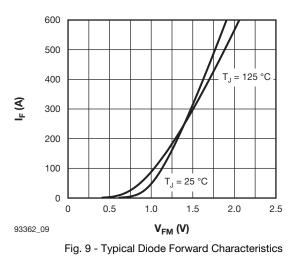
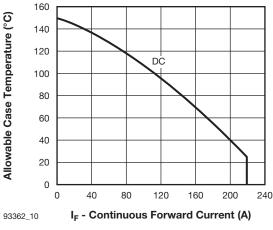
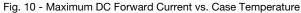


Fig. 8 - Typical IGBT Zero Gate Voltage Collector Current







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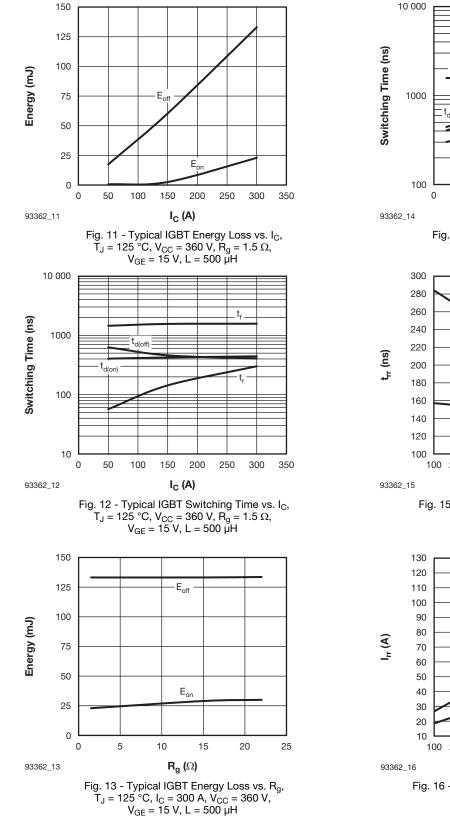
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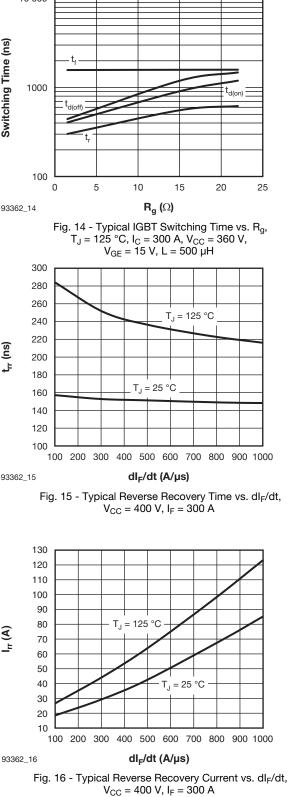


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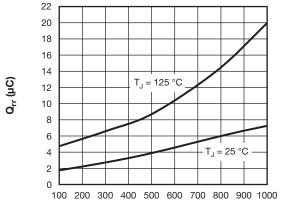
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For technical questions, contact: indmodules@vishay.com

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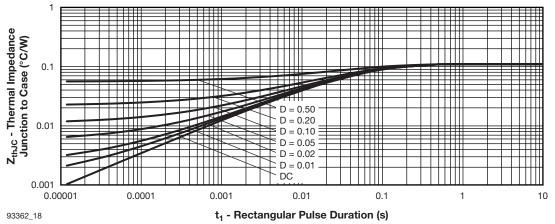




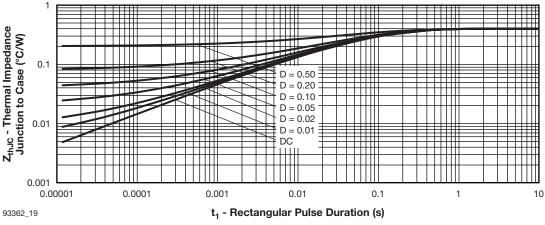


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Fig. 17 - Typical Reverse Recovery Charge vs. dl_F/dt, $V_{CC} = 400 \text{ V}, I_F = 300 \text{ A}$









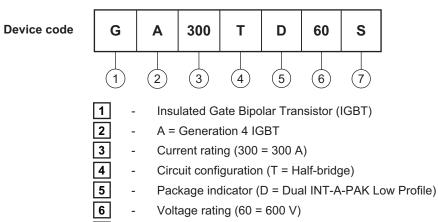
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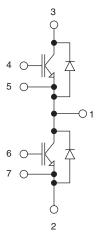
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ORDERING INFORMATION TABLE



7 Speed/type (S = Standard Speed IGBT)

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95435			



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